# Description

The HXY30P02DF uses advanced trench technology

to provide excellent R<sub>DS(ON)</sub>, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = -20V I_{D} = -30A$ 

 $R_{DS(ON)}$  < 15 m $\Omega$  @  $V_{GS}$ =4.5V

#### **Application**

Battery protection

Load switch

Uninterruptible power supply

# **Package Marking and Ordering Information**

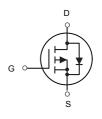
Product ID	Pack	Marking	Qty(PCS)
HXY30P02DF	DFN3X3-8L	30P02 XXX YYYY	5000

### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-20	V
VGS	Gate-Source Voltage	±12	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-30	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-18	А
IDM	Pulsed Drain Current <sup>2</sup>	-68	А
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	18	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-ambient <sup>1</sup>	75	°C/W
R₀JC	Thermal Resistance Junction-Case <sup>1</sup>	4.2	°C/W



DFN3X3-8L



P-Channel MOSFET



### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =-1mA		-0.012		V/°C
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-10A		12	15	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-8A		13	18	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> . In =-250uA	-0.4	-0.7	-1.0	٧
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS=VDS, ID =-230UA		2.94		mV/°C
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 12 \text{ V}$ , $V_{DS}=0 \text{ V}$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-10A		43		S
$Q_g$	Total Gate Charge (-4.5V)			35		
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =-10V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-10A		5.0		nC
$Q_gd$	Gate-Drain Charge			10		
$T_{d(on)}$	Turn-On Delay Time			12.0		
Tr	Rise Time	V <sub>DD</sub> =-10V , V <sub>GS</sub> =-4.5V ,		40.0		no
$T_{d(off)}$	Turn-Off Delay Time	R <sub>G</sub> =3.3Ω, I <sub>D</sub> =-10A		30		ns
T <sub>f</sub>	Fall Time			10		
Ciss	Input Capacitance			2800		
Coss	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		690		pF
Crss	Reverse Transfer Capacitance			590		

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,4</sup>	V- V- OV Force Current			-30.0	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current				Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	IF=-10A , dI/dt=100A/μs ,		27		nS
Qrr	Reverse Recovery Charge	TJ =25°C		17.8		nC

#### Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\, \leq \, 300 us$  , duty cycle  $\, \leq \, 2\%$
- 3.The power dissipation is limited by 150°C junction temperature
- 4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



#### **Typical Characteristics**

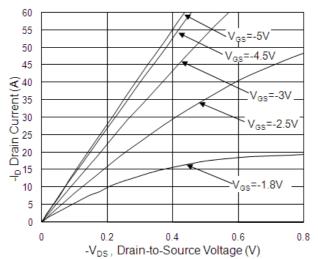


Fig.1 Typical Output Characteristics

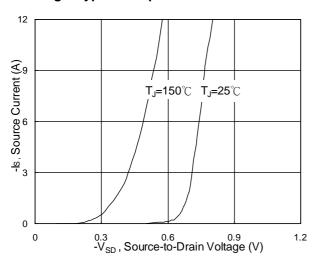


Fig.3 Forward Characteristics of Reverse

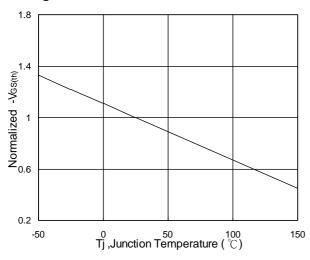


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

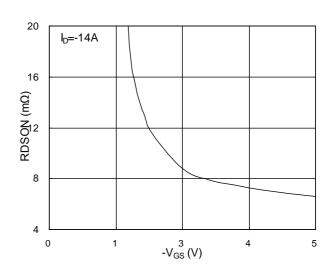


Fig.2 On-Resistance vs. G-S Voltage

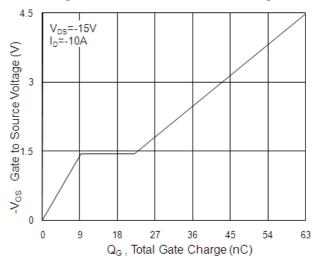


Fig.4 Gate-charge Characteristics

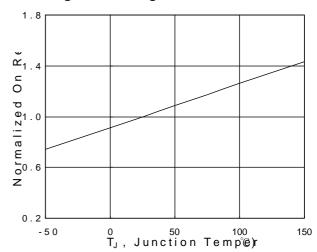
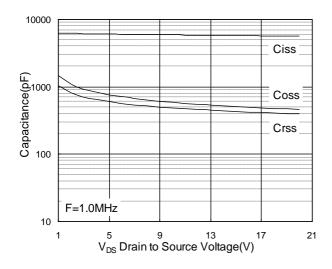


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





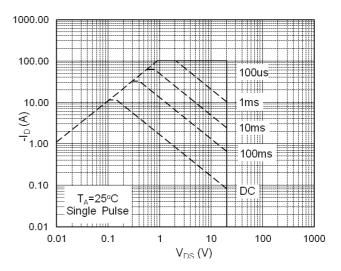


Fig.7 Capacitance

Fig.8 Safe Operating Area

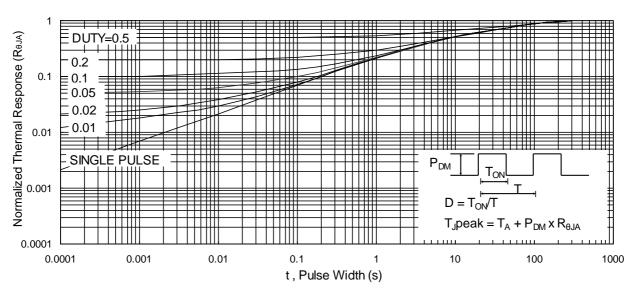
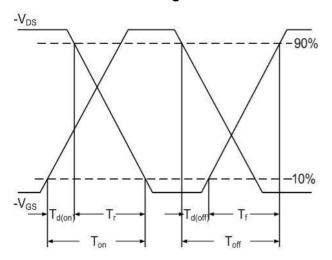


Fig.9 Normalized Maximum Transient Thermal Impedance



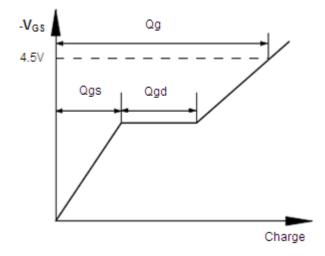
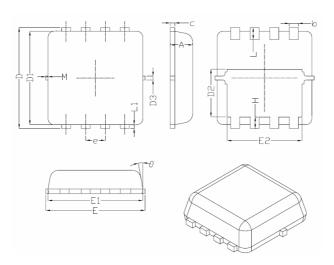


Fig.10 Switching Time Waveform

Fig.11 Gate Charge Waveform

## P-Channel Enhancement Mode MOSFET

## **DFN3X3-8L Package Information**



Complete I	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10 <sup>°</sup>	12 <sup>°</sup>	



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